

Call For Papers

• Microelectronic Devices and Materials

- Silicon Integrated Circuits Technologies
- Advance Memories Technology (Flash, FeRAM, PCM, RRAM, MRAM etc.)
- Sensors and MEMS
- Organic Semiconductor Devices and Technologies
- Silicon Photonics
- Nano-Electronic and Nano-Photonic Devices
- Physics and Simulation of Optoelectronic Devices



- Compound Semiconductor Materials, and Optoelectronic Devices
 - Compound Semiconductor Materials, Devices and Technologies
 - Optical Devices and Modules
 - Optical Communication
 - Fiber Optics and Fiber Sensing
 - Optical T hin Films
 - Laser Optics
 - Nano-Electronic and Nano-Photonic Devices
 - Physics and Simulation of Optoelectronic Devices



- Renewable and Sustainable Energy Device and Materials
 - Solid State Lighting and Displays
 - Organic, Inorganic, and Hybrid Photovoltaics
 - Nano-Electronic and Nano-Photonic Devices
 - Energy Harvesting and Transferring Mechanisms
 - Enabling Materials and Fabrication
 - Transparent and Flexible Optoelectronics
 - Renewable energy electronics



Integrated Circuits and Systems

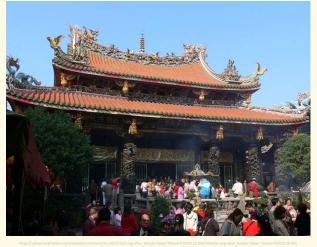
- Analog and Mixed-Signal Circuits and Systems
- Wireline and Wireless
 Communication Circuits and Systems
- Data Converters
- Power Management and Converters
- Sensors and Actuators
- Embedded Systems, Multi/Many Core Systems & Embedded Memory Technologies
- Reconfigurable and Programmable Circuits and Systems
- System L evel Design Methodology and Tools
- Design for Testability and Manufacturability
- Design Verification

Bioelectronics

- Processing/Devices/Circuits Modeling and Simulation
- Nano-Electronic and Nano-Photonic Devices
- Biomaterials
- Biomedical Devices
- MEMS & NEMS
- Sensors and Actuators
- Bioimages
- Bio Circuits and Systems



http://www-en.ntut.edu.tw/files/13-1128-37132.php



_ . .

- Sensors, Packaging Technologies, and Novel Applications in Science and Technology
 - Sensor and Photodetectors
 - Sensors and MEMS, Fiber Optics and Fiber Sensing
 - Reliability, Packaging and Testing Technologies, Sensors and Photodetectors
 - Package Technology
 - Sensor Application in Science and Technology
 - Sensors & Actuators
 - Sensors Materials
 - Sensors Technology

RF and Microwave Circuits

- RF circuits
- Microwave Circuits
- Millimeter Wave Techniques
- Antenna
- Electromagnetic Waves
- EMC & EMI

Computer Communication and Multimedia Techniques

- Computer Networks
- Software Defined Network (SDN)/ Network Function Virtualization (NFV)
- Internet Applications
- Communication Protocols
- 5G Architecture and Communications
- Multimedia Systems and Applications
- Embedded Systems and Applications
- Mobile Computing
- Video/ Audio Signal Processing
- Digital Signal Processing
- AR/VR technique
- Computer Vision
- Computer Graphics

• IOT and AI Techniques

- Internet of Things
- Internet of Vehicle
- Artificial Intelligence
- Machine Learning
- Deep Learning
- Cloud Computing
- Big Data
- Power and Control Engineering
 - Power Systems
 - Power Electronics
 - Motor Control
 - Remote Monitoring and Control
 - Home Automation

2018/3/10

- Intelligent Transportation Systems
- Automotive Electronics

Important Dates

- Paper submission: 2018/1/15
- Author notification: 2018/3/1
- Registration:
- Conference: 2018/ 5/ 7–5/ 9

http://isne2018.ntut.edu.tw

We look forward to your participation!